



3116 Page Street  
Redwood City, California 94063 USA  
Phone: 512-551-3377  
Fax: 650-365-4658  
email: [admin@ocpip.org](mailto:admin@ocpip.org)  
[www.ocpip.org](http://www.ocpip.org)

*For Release on November 19, 2009*

## **OCP-IP Releases OCP 3.0 Specification**

**Redwood City, CA — November 19, 2009 — Open Core Protocol International**

**Partnership (OCP-IP)** today announced that **OCP 3.0** specification has completed member review and is now the official specification of record. This latest version contains extensions to support **cache coherence** and more aggressive **power management**, as well as an additional **high-speed consensus profile** and other new elements.

**Embedded processors** commonly used in **SoCs** often use local caches to improve performance and reduce power by storing frequently referenced storage locations in high bandwidth low latency local memories. Keeping such caches coherent with the

external memories that they shadow requires either careful software engineering or costly hardware resources that have been considered too expensive for most SoCs. However, maintaining coherence in embedded software has become increasingly complex so the OCP 3.0 coherence extensions are included to enable hardware-based coherence among the wide variety of **heterogeneous CPUs, DSPs, accelerators and streaming input/output devices** that characterize advanced SoCs.

The OCP extensions differ from traditional coherence approaches by cleanly separating the primitive operations associated with maintaining coherence from the specific **system-level** approach for implementing the communication and storage aspects of a coherent system. This extends a key advantage of OCP – the ability to develop IP cores independently from the system in which they will be used – into the domain of cache coherent systems. In particular, the OCP coherence extensions have been validated against both **invalidate-based snoopy** and **directory-based** coherence schemes. A detailed [technical article](#) on cache coherence is available on the OCP-IP website.

Designers are increasingly implementing power management protocols on chip, as power minimization has become critical in most electronic systems, OCP 3.0 defines a new **connection protocol** that allows the **power management hardware** to disconnect

the OCP interface without losing any transaction so the manager may then independently shut off power. A detailed technical article on power management is available [here](#).

Consensus profiles provide company engineers with standardized configurations of OCP options for specific system use cases, ensuring **interoperability**. A third profile (Profile 3) has been added in OCP 3.0. Profile 1 is a simple slave profile. Profile 2 is a high-speed profile, and Profile 3 is an advanced high-speed profile needed for high speed CPUs, high-performance video graphics accelerators and DRAMS. For a detailed technical article on consensus profiles, click [here](#).

Work on OCP 3.0 was executed by members of the OCP-IP Specification Working Group including: **MIPS Technologies, Nokia, Sonics Inc, Texas Instruments, Toshiba** and other industry leading companies.

For the latest information on OCP-IP please see our newsletter at: <http://www.ocpip.org/newsletters.php>

### **About OCP-IP**

Formed in 2001, OCP-IP is a non-profit corporation promoting, supporting and delivering the only openly licensed, **core-centric protocol** comprehensively fulfilling

integration requirements of **heterogeneous multicore** systems. The Open Core Protocol (OCP) facilitates IP **core reusability** and reduces design time, risk, and manufacturing costs for all SoC and **electronic designs** by providing a comprehensive supporting infrastructure. For additional background and membership information, visit [www.OCP-IP.org](http://www.OCP-IP.org).

**For additional information, please contact:**

**Ian Mackintosh, OCP-IP**  
408-761-5980  
[ian@ocpip.org](mailto:ian@ocpip.org)

**Joe Basques, VitalCom**  
512-551-3377  
[joe@vitalcompr.com](mailto:joe@vitalcompr.com)

NOTE: All trademarks and service marks are the property of their respective owners.

###